

Detector Switch > SPPB Series > SPPB530601

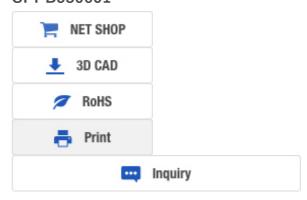
General-purpose Type SPPB Series

| <u>Dimensions</u> | <u>Land Dimensions</u> | <u>Circuit Diagram</u> | <u>Packing Specifications</u> |

| Soldering Conditions



Part number <u>Series Common Info</u> **SPPB530601**



Operating direction Vertical

Poles 1

Positions 1

Operation part shape Push

Terminal type For PC board (Reflow)

Operating force 0.35N max.

Packaging style Taping

Operating temperature range

Rating (max.)/(min.) (Resistive load)

-40°C to +85°C

 $0.1A\ 30V\ DC/50\ \mu\ A$

3V DC

Electrical performance Contact resistance (Initial/After operating 1Ω max./ 2Ω max. life)

> $100M\Omega$ min. 100VInsulation resistance DC

100V AC for 1 minute Voltage proof

Terminal strength 3N for 1 minute Mechanical

performance Actuator strength 10N

> 50,000 cycles 2Ω Operating life without load

max. Durability

Operating life with load Rating (max.) 50,000 cycles 2Ω

> (Resistive load) max.

Cold -40°C 500h

Environmental Dry heat 85°C 500h

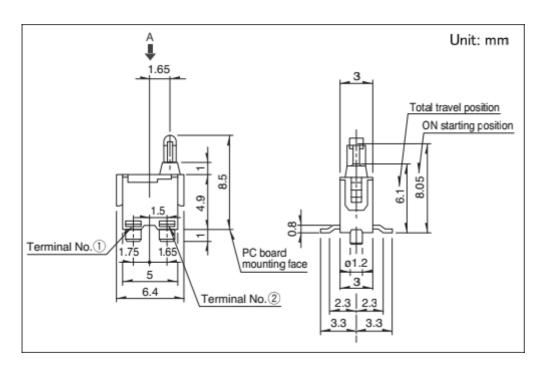
performance 60°C, 90 to 95%RH Damp heat

500h

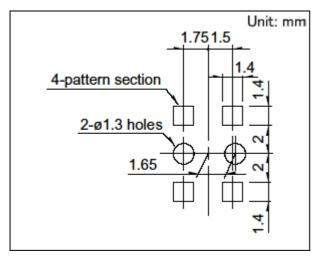
Japan 600 Minimum order unit (pcs.)

Export 2,400

Dimensions

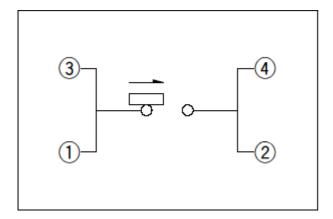


Land Dimensions



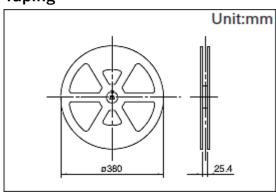
Viewed from direction A in the dimensions.

Circuit Diagram



Packing Specifications

Taping



Number of

1 reel

600

packages (pcs.)

1 case / Japan 1,200

1 case / export packing 2,400

Tape width (mm) 24

Export package measurements (mm) $406 \times 406 \times 160$

Soldering Conditions

Example of Reflow Soldering Condition

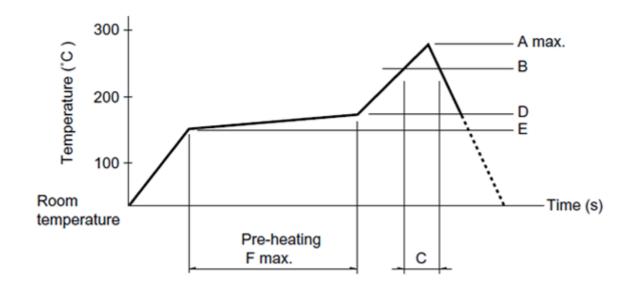
1. Heating method

Double heating method with infrared heater.

2. Temperature measurement

Thermocouple 0.1 to 0.2VCA (K) or CC (T) at soldering portion (copper foil surface). A heat resisting tape should be used for fixed measurement.

3. Temperature profile



- (1) The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- (2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Reference for Hand Soldering

Soldering temperature $350 \pm 5^{\circ}$ C Soldering time 5s max.

Notes are common to this series/models.

- 1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.
- 2. Please place purchase orders per minimum order unit (integer).
- 3. This products can be used in vehicles.

 Although these products are designed to perform over a wide operating temperature range, please ensure that you receive and read the formal delivery specifications before use.

Inquiries about Products

<u>Inquiry</u>

COPYRIGHT© 2020 ALPS ALPINE CO., LTD